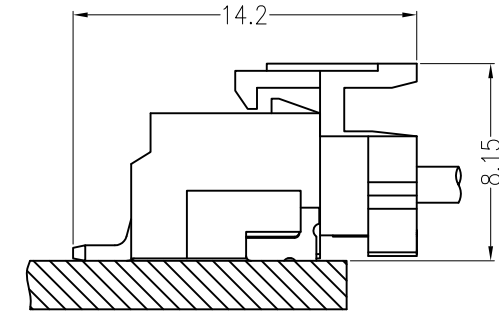
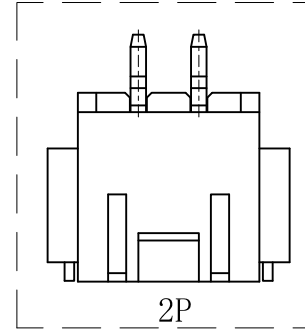
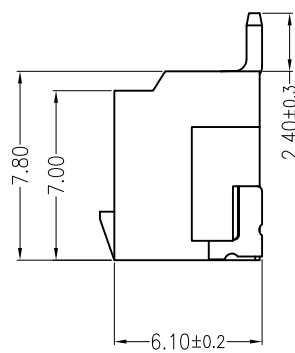
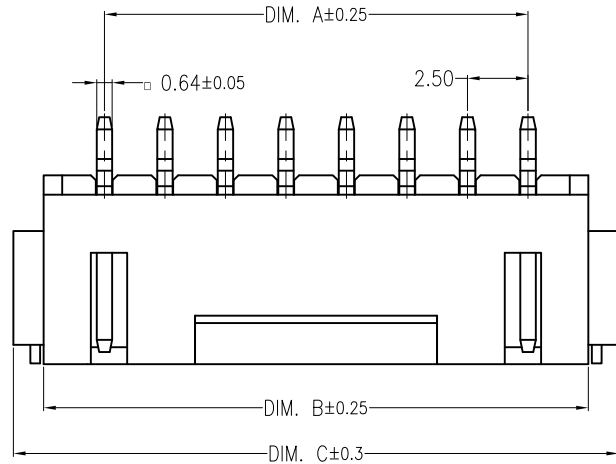
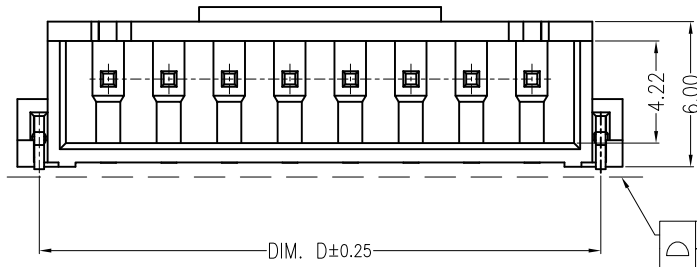


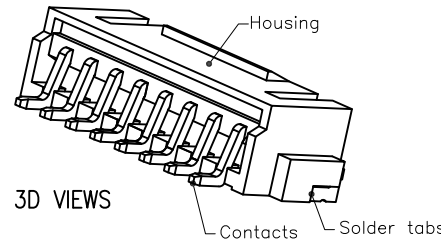
修订 REV	标记 MARK	修改摘要 REVISION DESCRIPTION	签名 SIGNATURE	日期 DATE
AO		NEW RELEASE	黄艳兰	2020-06-18



Assembly Layout



02P~11P	0.10	MAX
12P~16P	0.12	MAX

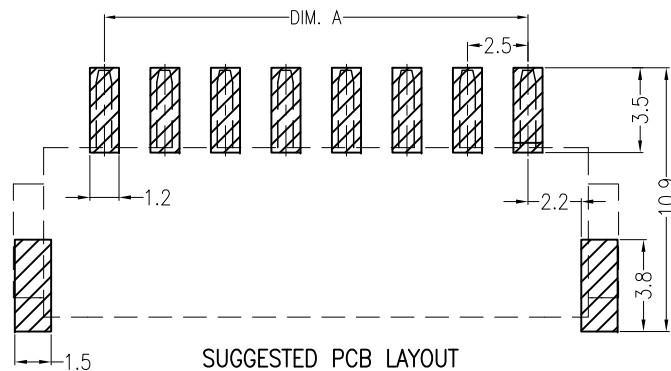


3D VIEWS

**Specifications:**

Contact resistance:  $\leq 20m\Omega$   
 Insulation resistance:  $\geq 1000M\Omega$   
 Rated voltage: 250V AC DC  
 Rated current: 3.0A AC DC  
 Withstand voltage: 1000V AC/minute  
 Temperature range:  $-25^{\circ}C \sim +105^{\circ}C$   
 Housing: LCP, UL94V-0, Natural  
 Contacts: Brass/Sn  
 Solder tabs: Brass/Sn

Circuit	Dimensions (mm)			
	DIM. A	DIM. B	DIM. C	DIM. D
02	2.50	7.50	10.00	8.20
03	5.00	10.00	12.50	10.70
04	7.50	12.50	15.00	13.20
05	10.00	15.00	17.50	15.70
06	12.50	17.50	20.00	18.20
07	15.00	20.00	22.50	20.70
08	17.50	22.50	25.00	23.20
09	20.00	25.00	27.50	25.70
10	22.50	27.50	30.00	28.20
11	25.00	30.00	32.50	30.70
12	27.50	32.50	35.00	33.20
13	30.00	35.00	37.50	35.70
14	32.50	37.50	40.00	38.20
15	35.00	40.00	42.50	40.70
16	37.50	42.50	45.00	43.20



SUGGESTED PCB LAYOUT



**深圳市华德共创科技有限公司**  
 Shenzhen Huade co-create Technology Co.,LTD  
 TEL : 0755-27129737 FAX : 0755-29940187

-TOLERANCES- UNLESS OTHERWISE SPECIFIED 公差参数表				 		TITLE: 产品名称: XH2.5卧贴(带扣)			
X.X	±0.30	X.X°	±3°	APPD: 核准: 谢亮		PART NO: 产品编号: HDGC2512WR-S-XP			
X.XX	±0.30	X.XX°	±2°	CHECK: 校对: 王建业		DATE	SCALE	UNIT	CODE NUMBER
X.XXX	±0.10	X.XXX°	±1°	DRAW: 绘图: 黄艳兰		2020-06-18	1:1	mm	A018